

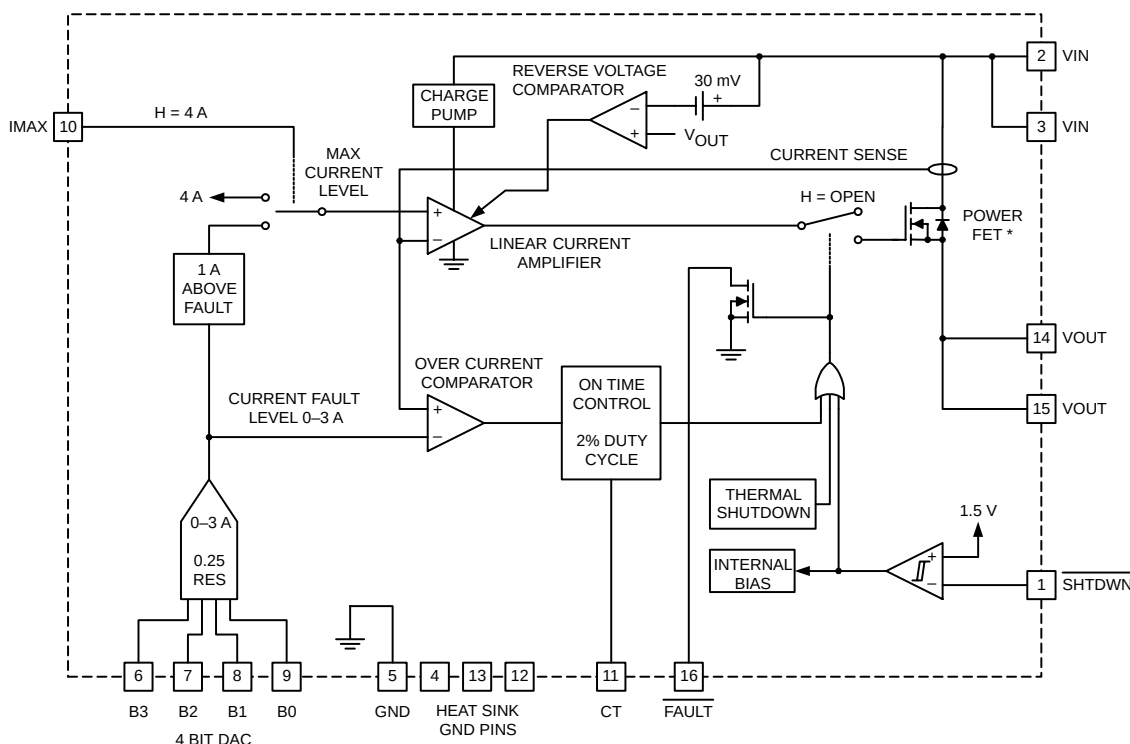
- Integrated 0.15-Ω Power MOSFET
- 7-V to 15-V Operation
- Digital-Programmable Current Limit from 0 A to 3 A
- 100-μA I_{CC} When Disabled
- Programmable On Time
- Programmable Start Delay
- Fixed 2% Duty Cycle
- Thermal Shutdown
- Fault-Output Indicator
- Maximum-Output Current Can Be Set to 1 A Above the Programmed-Fault Level or to a Full 4 A
- Power SOIC and TSSOP, Low Thermal Resistance Packaging

description

The UCC3915 programmable hot swap power manager provides complete power-management, hot-swap capability, and circuit breaker functions. The only external component required to operate the device, other than power supply bypassing, is the fault-timing capacitor, C_T . All control and housekeeping functions are integrated, and externally programmable. These include the fault current level, maximum output sourcing current, maximum fault time, and startup delay. In the event of a constant fault, the internal fixed 2% duty cycle ratio limits average output power.

The internal 4-bit DAC allows programming of the fault-level current from 0 A to 3 A with 0.25-A resolution. The IMAX control pin sets the maximum-sourcing current to 1 A above the trip level or to a full 4 A of output current for fast output capacitor charging. (continued)

block diagram



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NOTE: Pin numbers refer to DIL-16 and SOIC-16 packages.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

TEXAS
INSTRUMENTS

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UCC2915, UCC3915

15-V PROGRAMMABLE HOT SWAP POWER MANAGER

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description (continued)

When the output current is below the fault level, the output MOSFET is switched on with a nominal ON resistance of $0.15\ \Omega$. When the output current exceeds the fault level, but is less than the maximum-sourcing level, the output remains switched on, but the fault timer starts, charging CT. Once CT charges to a preset threshold, the switch is turned off, and remains off for 50 times the programmed fault time. When the output current reaches the maximum sourcing level, the MOSFET transitions from a switch to a constant current source.

The UCC3915 can be put into sleep mode, drawing only $100\ \mu\text{A}$ of supply current. Other features include an open-drain fault-output indicator, thermal shutdown, undervoltage lockout, 7-V to 15-V operation, and low-thermal resistance SOIC and TSSOP power packages.

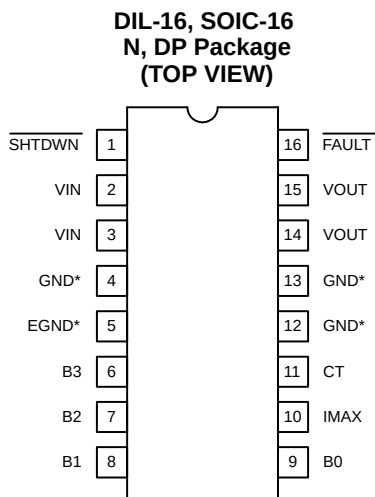
absolute maximum ratings over operating free-air temperature (unless otherwise noted)[†]

VIN	15.5 V
VOUT – VIN	0.3 V
FAULT sink current	50 mA
FAULT voltage	–0.3 V to 8 V
Output current	Self limiting
TTL input voltage	–0.3 to VIN
Storage temperature, T_{stg}	–65°C to 150°C
Junction temperature, T_J	–55°C to 150°C
Lead temperature (soldering, 10 sec.)	300°C

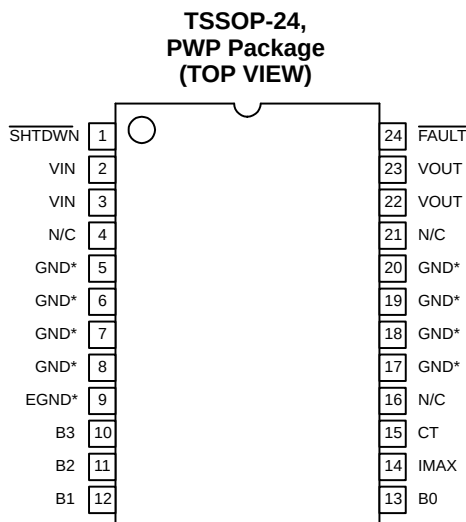
[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

[‡] Currents are positive into, negative out of the specified terminal. Consult Packaging Section of the *Interface Products Data Book* (TI Literature Number SLUD002) for thermal limitations and considerations of packages.

package information



*Pin 5 serves as lowest impedance to the electrical ground; Pins 4, 12, and 13 serve as heat sink/ground. These pins should be connected to large etch areas to help dissipate heat. For N Package, pins 4, 12, and 13 are N/C.



*Pin 9 serves as lowest impedance to the electrical ground; other GND pins serve as heat sink/ground. These pins should be connected to large etch areas to help dissipate heat.

UCC2915, UCC3915 15-V PROGRAMMABLE HOT SWAP POWER MANAGER

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electrical characteristics, these specifications apply for $T_A = -40^{\circ}\text{C}$ to 85°C for the UCC2915 and 0°C to 70°C for the UCC3915, $V_{IN} = 12\text{ V}$, $I_{MAX} = 0.4\text{ V}$, $SHTDWN = 2.4\text{ V}$, $T_A = T_J$, (unless otherwise stated)

supply

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Voltage input range		7.0		15.0	V
Supply current			1.0	2.0	mA
Sleep mode current	$\overline{SHTDWN} = 0.2\text{ V}$, no load		100	150	μA
Output leakage	$\overline{SHTDWN} = 0.2\text{ V}$			20	μA

NOTE 1: All voltages are with respect to GND. Current is positive into and negative out of the specified terminal.

output

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Voltage drop	$I_{OUT} = 1\text{ A}$ (10 V to 12 V)		0.15	0.3	V
	$I_{OUT} = 2\text{ A}$ (10 V to 12 V)		0.3	0.6	V
	$I_{OUT} = 3\text{ A}$ (10 V to 12 V)		0.45	0.9	V
	$I_{OUT} = 1\text{ A}$, $V_{IN} = 7\text{ V}$ and 15 V		0.2	0.4	V
	$I_{OUT} = 2\text{ A}$, $V_{IN} = 7\text{ V}$ and 15 V		0.4	0.8	V
	$I_{OUT} = 3\text{ A}$, $V_{IN} = 7\text{ V}$, 12 V MAX		0.6	1.2	V
Initial startup time	See Note 2		100		μs
Short circuit response	See Note 2		100		ns
Thermal shutdown	See Note 2		165		$^{\circ}\text{C}$
Thermal hysteresis	See Note 2		10		$^{\circ}\text{C}$

NOTE 1: All voltages are with respect to GND. Current is positive into and negative out of the specified terminal.

NOTE 2: Ensured by design. Not production tested.

DAC

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Trip current	Code = 0000–0011 (device off)				
	Code = 0100	0.07	0.25	0.45	A
	Code = 0101	0.32	0.50	0.70	A
	Code = 0110	0.50	0.75	0.98	A
	Code = 0111	0.75	1.00	1.3	A
	Code = 1000	1.0	1.25	1.6	A
	Code = 1001	1.25	1.50	1.85	A
	Code = 1010	1.5	1.75	2.15	A
	Code = 1011	1.70	2.00	2.4	A
	Code = 1100	1.90	2.25	2.7	A
	Code = 1101	2.1	2.50	2.95	A

NOTE 1: All voltages are with respect to GND. Current is positive into and negative out of the specified terminal.



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electrical characteristics, these specifications apply for $T_A = -40^{\circ}\text{C}$ to 85°C for the UCC2915 and 0°C to 70°C for the UCC3915, $V_{IN} = 12\text{ V}$, $I_{MAX} = 0.4\text{ V}$, $SHTDWN = 2.4\text{ V}$, $T_A = T_J$, (unless otherwise stated)

DAC (continued)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Trip current	Code = 1110	2.30	2.75	3.25	A
	Code = 1111	2.50	3.0	3.50	A
Max output current over trip (current source mode)	Code = 0100 to 1111, $I_{MAX} = 0\text{ V}$	0.35	1.0	1.65	A
Max output current (current source mode)	Code = 0100 to 1111, $I_{MAX} = 2.4\text{ V}$	3.0	4.0	5.2	A

NOTE 1: All voltages are with respect to GND. Current is positive into and negative out of the specified terminal.

fault timer

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
CT charge current	$V_{CT} = 1.0\text{ V}$	-83	-62	-47	μA
CT discharge current	$V_{CT} = 1.0\text{ V}$	0.8	1.2	1.8	μA
Output duty cycle	$V_{OUT} = 0\text{ V}$	1.0%	1.9%	3.3%	
CT fault threshold		1.2	1.5	1.7	V
CT reset threshold		0.4	0.5	0.6	V

NOTE 1: All voltages are with respect to GND. Current is positive into and negative out of the specified terminal.

shutdown

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Shutdown threshold		1.1	1.5	1.9	V
Shutdown hysteresis			150		mV
Input current			100	500	nA

NOTE 1: All voltages are with respect to GND. Current is positive into and negative out of the specified terminal.

open drain output ($\overline{\text{FAULT}}$)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
High level output current	$\overline{\text{FAULT}} = 5\text{ V}$			250	μA
Low level output voltage	$I_{OUT} = 5\text{ mA}$		0.2	0.8	V

NOTE 1: All voltages are with respect to GND. Current is positive into and negative out of the specified terminal.

TTL input dc characteristics

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
TTL input voltage high		2.0			V
TTL input voltage low				0.8	V
TTL input high current	$V_{IH} = 2.4\text{ V}$		3	10	μA
TTL input low current	$V_{IL} = 0.4\text{ V}$			1	μA

NOTE 1: All voltages are with respect to GND. Current is positive into and negative out of the specified terminal.



VOUT: Output voltage from the UCC3915. Both VOUT pins should be connected together and connected to the load. When switched the output voltage will be approximately $V_{IN} - (0.15 \Omega \times I_{OUT})$. VOUT must not exceed VIN by greater than 0.3 V.

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APPLICATION INFORMATION

protecting the UCC3915 from voltage transients

The parasitic inductance associated with the power distribution can cause a voltage spike at V_{IN} if the load current is suddenly interrupted by the UCC3915. It is important to limit the peak of this spike to less than 15 V to prevent damage to the UCC3915. This voltage spike can be minimized by:

- Reducing the power distribution inductance (e.g., twist the positive (+) and negative (–) leads of the power supply feeding V_{IN} , locate the power supply close to the UCC3915 or use PCB power and ground planes).
- Decoupling V_{IN} with a capacitor, C_{IN} (refer to Figure 1), located close to the V_{IN} pins. This capacitor is typically 1 μ F or less to limit the inrush current.
- Clamping the voltage at V_{IN} below 15 V with a Zener diode, D1 (refer to Figure 1), located close to the V_{IN} pins.

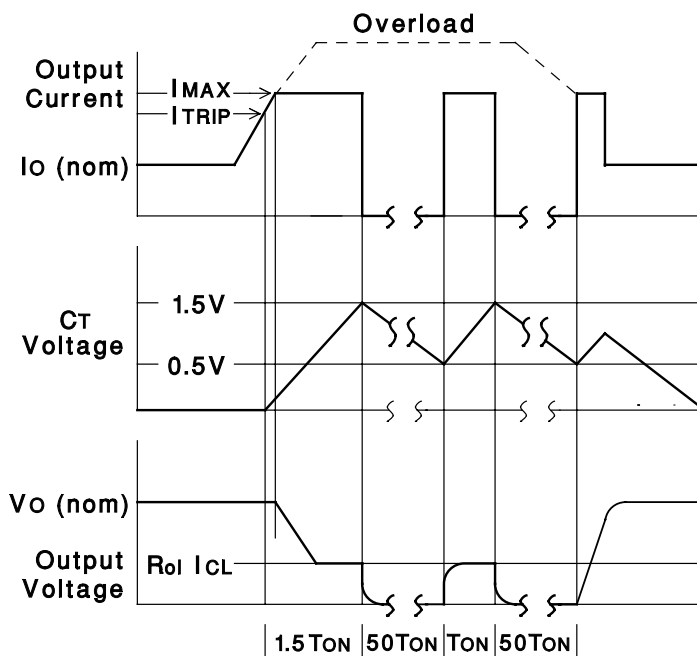


Figure 2. Load Current, Timing-Capacitor Voltage, and Output Voltage of the UCC3915 Under Fault Conditions

estimating maximum load capacitance

For hot-swap applications, the rate at which the total output capacitance can be charged depends on the maximum-output current available and the nature of the load. For a constant-current, current-limited application, the output will come up if the load asks for less than the maximum available short-circuit current.

To ensure recovery of a duty cycle from a short-circuited load condition, there is a maximum total output capacitance which can be charged for a given unit on time (fault time). The design value of on or fault time can be adjusted by changing the timing capacitor C_T .

APPLICATION INFORMATION

For worst-case constant-current load of value just less than the trip limit; $C_{OUT(max)}$ can be estimated from:

$$C_{OUT(max)} \approx (I_{MAX} - I_{LOAD}) \times \left(\frac{16.1 \times 10^3 \times C_T}{V_{OUT}} \right)$$

Where V_{OUT} is the output voltage.

For a resistive load of value R_L , the value of $C_{OUT(max)}$ can be estimated from:

$$C_{OUT(max)} \approx \left[\frac{16.1 \times 10^3 \times C_T}{R_L \times \ln \left[\frac{1}{1 - \frac{V_{OUT}}{I_{MAX} \times R_L}} \right]} \right]$$

Long C_T times must consider the maximum temperature. Thermal shutdown protection may be the limiting fault time.

safety recommendations

Although the UCC3915 is designed to provide system protection for all fault conditions, all integrated circuits can ultimately fail short. For this reason, if the UCC3915 is intended for use in safety-critical applications where UL or some other safety rating is required, a redundant safety device such as a fuse should be placed in series with the device. The UCC3915 will prevent the fuse from blowing for virtually all fault conditions, increasing system reliability and reducing maintenance cost, in addition to providing the hot-swap benefits of the device.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
UCC2915DP	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UCC2915DP
UCC2915DP.A	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UCC2915DP
UCC3915DP	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UCC3915DP
UCC3915DP.A	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UCC3915DP
UCC3915DPTR	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UCC3915DP
UCC3915DPTR.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UCC3915DP

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

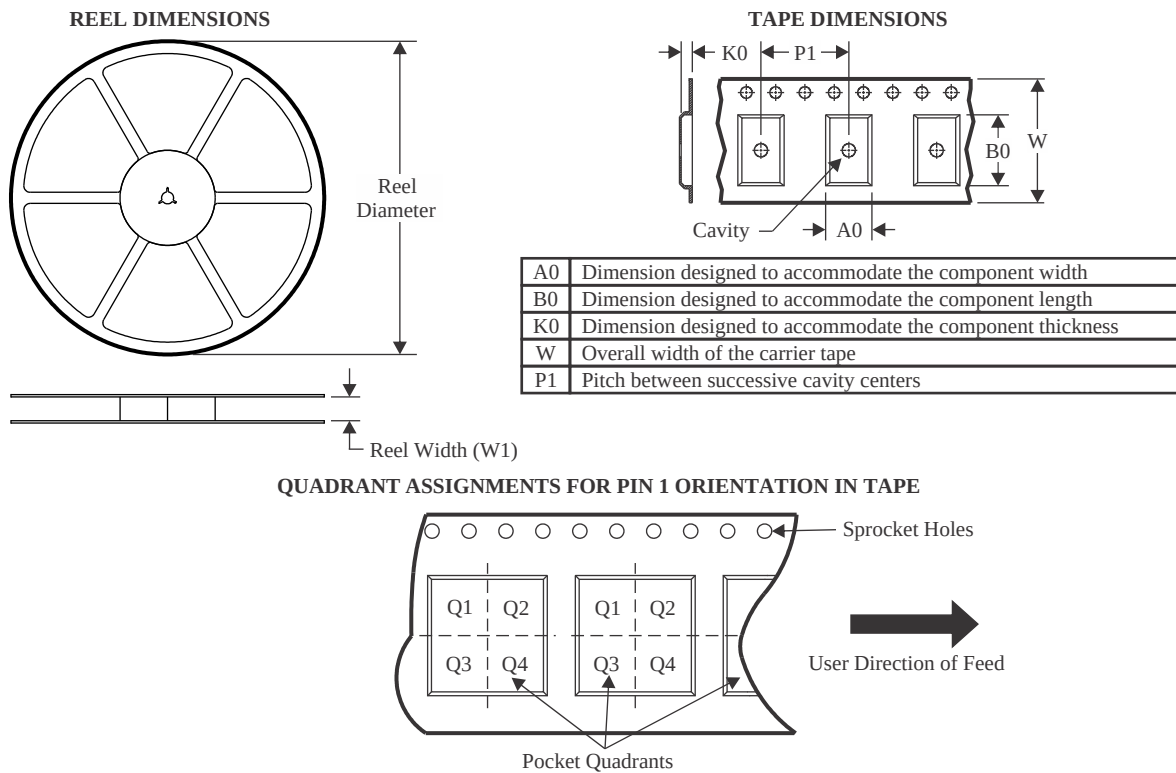
⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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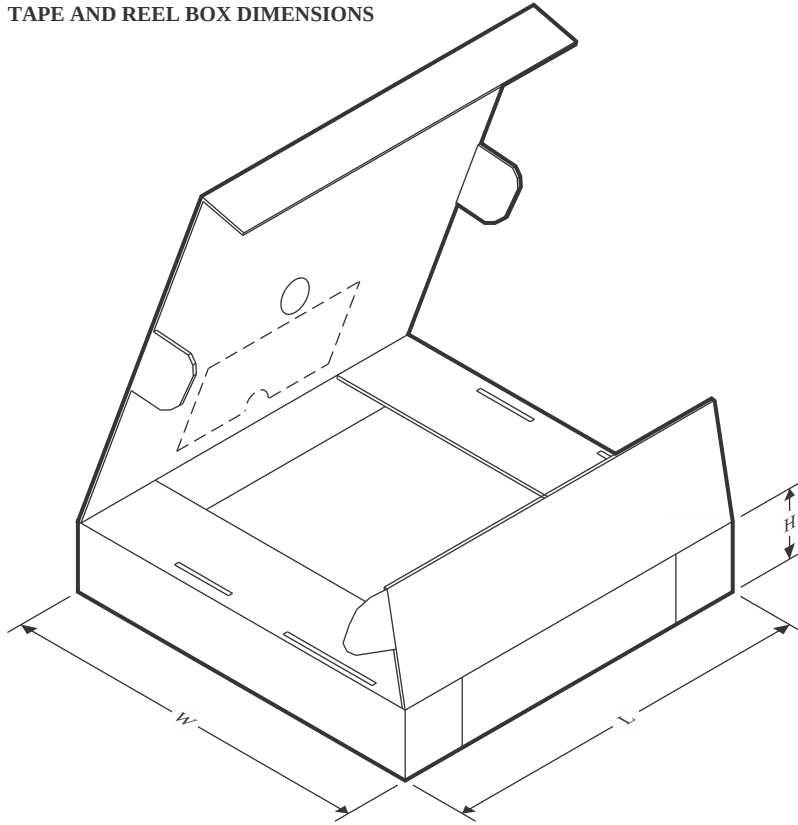
TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UCC3915DPTR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

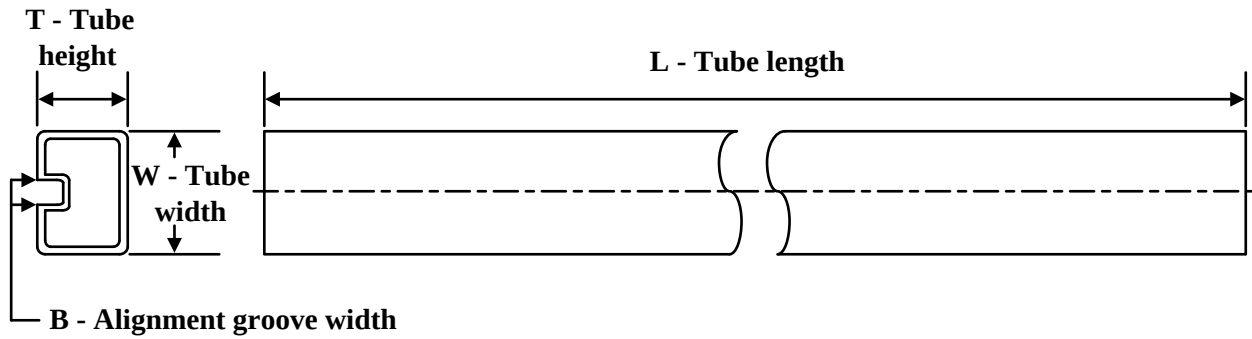
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
UCC3915DPTR	SOIC	D	16	2500	353.0	353.0	32.0

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
UCC2915DP	D	SOIC	16	40	506.6	8	3940	4.32
UCC2915DP.A	D	SOIC	16	40	506.6	8	3940	4.32
UCC3915DP	D	SOIC	16	40	506.6	8	3940	4.32
UCC3915DP.A	D	SOIC	16	40	506.6	8	3940	4.32

GENERIC PACKAGE VIEW

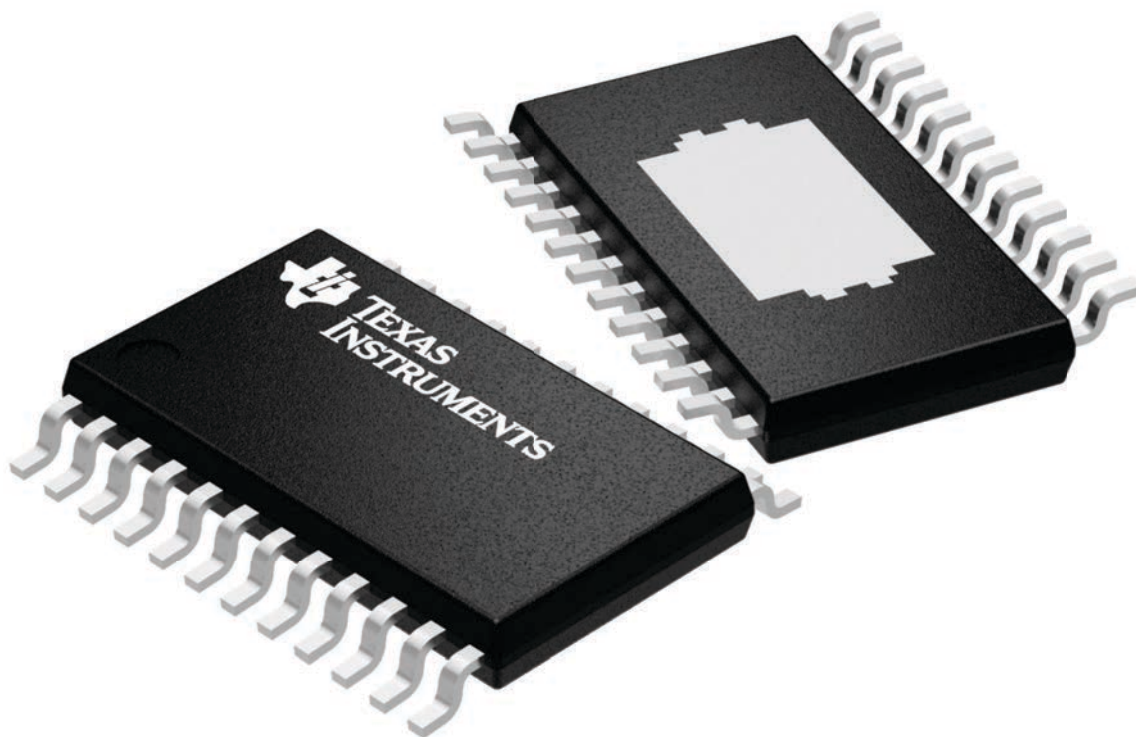
PWP 24

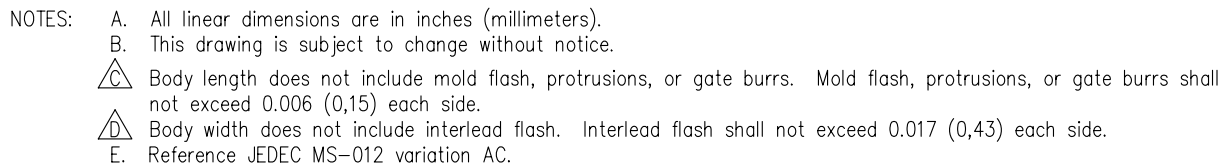
PowerPAD™ TSSOP - 1.2 mm max height

4.4 x 7.6, 0.65 mm pitch

PLASTIC SMALL OUTLINE

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

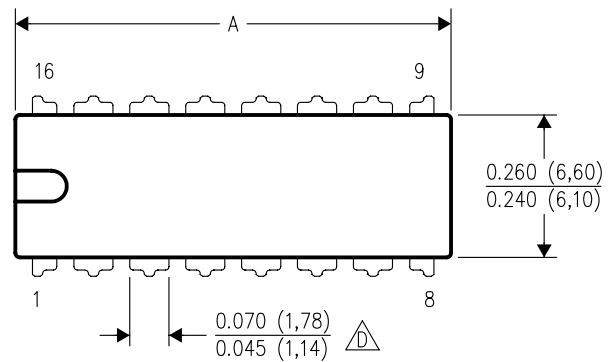




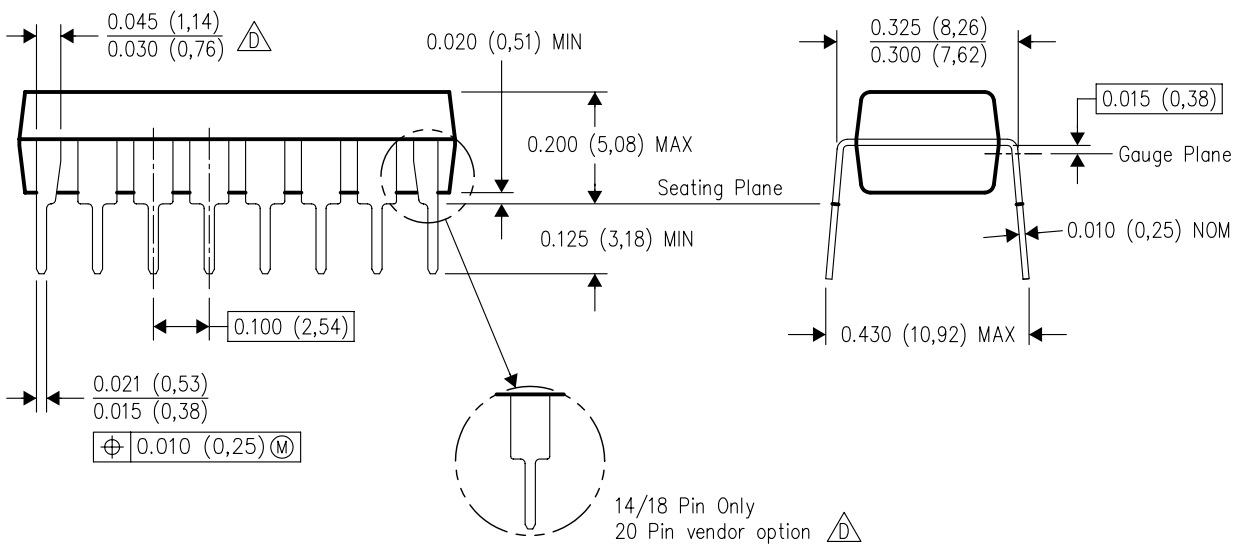
N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS **	14	16	18	20
DIM				
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



14/18 Pin Only
20 Pin vendor option

4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

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